

one or more projections, and with each reciprocally-displaceable mounting member being biased via a first bias away from the other member of the pair;

a mechanism configured to selectively apply a second bias to each biased member to counteract the first bias and displace the biased member toward the other member of the pair; and

a stencil comprising a central body having one or more apertures formed through the stencil thickness to define a pattern for printing solder on said substrate, said central body of said stencil defined by four peripheral edges, wherein each of said four peripheral edges of said stencil comprises a plurality of receiving apertures, said receiving apertures configured to receive said projections of each of said mounting members such that when the second bias is not applied, said stencil is tensioned along two orientations.

*B1
(concluded)*